



60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| BV _{DSS} | R _{DS(ON)} max | I _D max T _A = 25°C |
|-------------------|-------------------------------|---|
| 60V | 8mΩ @ V _{GS} = 10V | 14.0A |
| | 12mΩ @ V _{GS} = 4.5V | 11.5A |

Description and Applications

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in notebook battery power management and loadswitch.

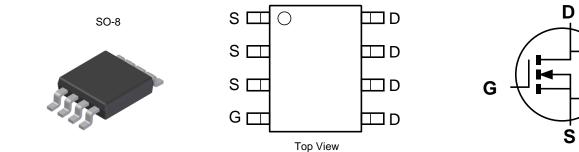
- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

Top View

| Part Number | Case | Packaging |
|---------------|------|-------------------|
| DMT6010LSS-13 | SO-8 | 2,500/Tape & Reel |

Internal Schematic

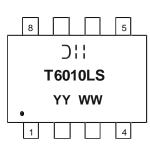
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



)|| = Manufacturer's Marking T6010LS = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 13 = 2013) WW = Week (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | | Symbol | Value | Units |
|---|-----------------|--|------------------|--------------|-------|
| Drain-Source Voltage | | | V _{DSS} | 60 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 6) V _{GS} = 10V | Steady State | $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$ | ID | 14.0 11.0 | А |
| | t<10s | T _A = +25°C T _A = +70°C | ID | 16.7 13.5 | А |
| Maximum Continuous Body Diode Forward Current (Note 6) | | | I _S | 3 | A |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | | | I _{DM} | 80 | A |
| Avalanche Current, L = 0.1mH | | | I _{AS} | 20 | A |
| Avalanche Energy, L = 0.1mH | | | E _{AS} | 20 | mJ |

Thermal Characteristics

| Characteristic | Symbol | Value | Units | |
|--|--------------|----------------------|-------------|------|
| Total Power Dissipation (Note 5) | | PD | 1.5 | W |
| Thermal Basistones, Junction to Ambient (Note 5) | Steady State | D | 80 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 5) | t<10s | R _{θJA} | 48 | °C/W |
| Total Power Dissipation (Note 6) | | PD | 2.0 | W |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | P | 53 | °C/W |
| memai Resistance, Junction to Ambient (Note 6) | t<10s | R _{θJA} | 37 | °C/W |
| Thermal Resistance, Junction to Case (Note 6) | | R _{eJC} | 6.5 | °C/W |
| Operating and Storage Temperature Range | | TJ, T _{STG} | -55 to +150 | °C |

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

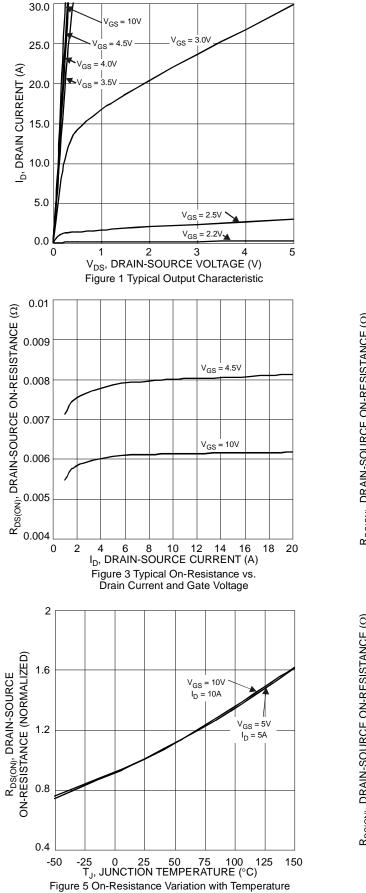
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|--|---------------------|-------|-------|------|------|---|--|
| OFF CHARACTERISTICS (Note 7) | Cymbol | WIIII | - YP | Max | Onit | Test condition | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | | _ | V | $V_{GS} = 0V, I_{D} = 250 \mu A$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1 | μA | $V_{DS} = 48V, V_{GS} = 0V$ | |
| Gate-Source Leakage | IGSS | | | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | | | • | |
| Gate Threshold Voltage | V _{GS(TH)} | 0.8 | — | 2.0 | V | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance | | | 6 | 8 | mΩ | $V_{GS} = 10V, I_D = 20A$ | |
| Static Drain-Source On-Resistance | R _{DS(ON)} | | 8 | 12 | | $V_{GS} = 4.5V, I_D = 20A$ | |
| Diode Forward Voltage | V _{SD} | | 0.9 | 1.2 | V | $V_{GS} = 0V, I_{S} = 20A$ | |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | | |
| Input Capacitance | Ciss | | 2,090 | — | | | |
| Output Capacitance | Coss | | 746 | - | pF | $V_{DS} = 30V, V_{GS} = 0V,$ f = 1MHz | |
| Reverse Transfer Capacitance | C _{rss} | | 38.5 | — | | I = I I V I I Z | |
| Gate resistance | R _G | | 0.59 | - | Ω | $V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$ | |
| Total Gate Charge (V _{GS} = 4.5V) | Qg | | 19.3 | — | | | |
| Total Gate Charge (V _{GS} = 10V) | Qg | | 41.3 | - | nC | V _{DS} = 30V, I _D = 20A | |
| Gate-Source Charge | Q _{gs} | | 6.0 | - | ne | | |
| Gate-Drain Charge | Q _{gd} | _ | 8.8 | — | | | |
| Turn-On Delay Time | t _{D(ON)} | _ | 5.7 | — | | | |
| Turn-On Rise Time | t _R | | 4.3 | _ | ns | $V_{DD} = 30V, V_{GS} = 10V,$ | |
| Turn-Off Delay Time | t _{D(OFF)} | | 23.4 | _ | 115 | $I_D = 20A, R_G = 3\Omega$ | |
| Turn-Off Fall Time | t _F | _ | 9.7 | _ | | | |

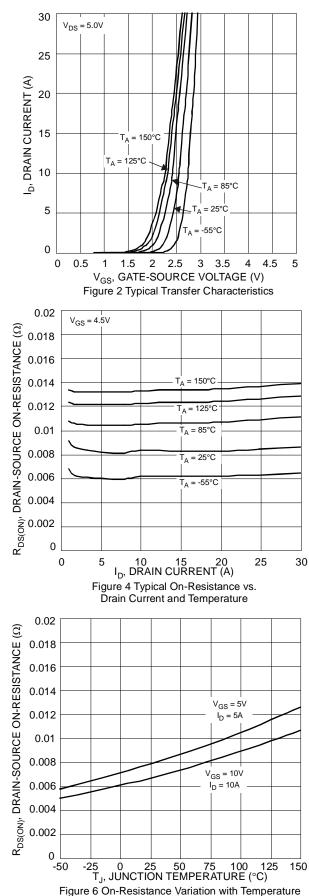
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to product testing.

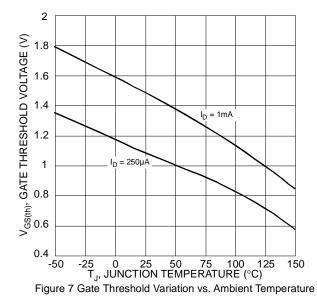


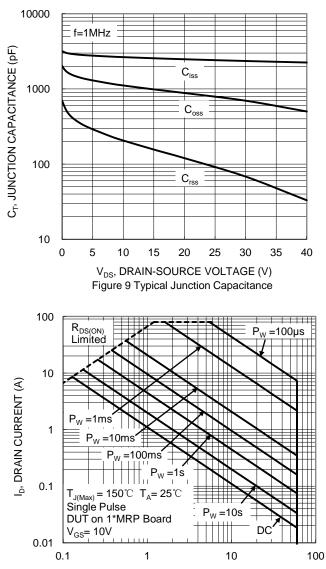




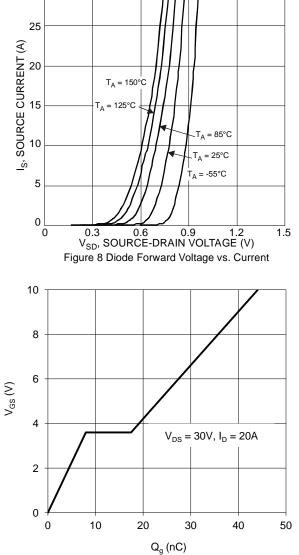










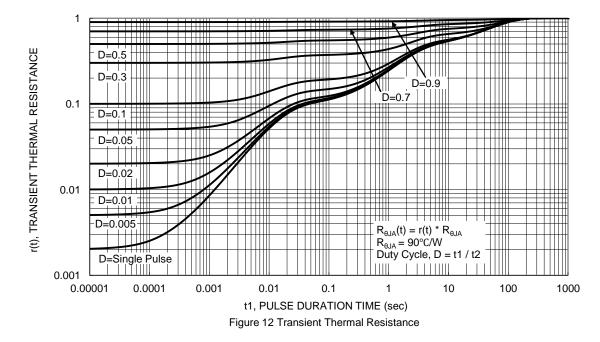


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Figure 10 Gate Charge



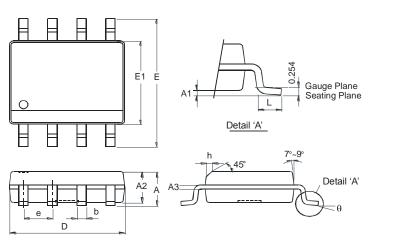






Package Outline Dimensions

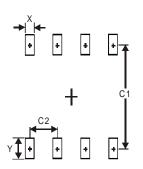
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version



| SO-8 | | | | | |
|----------------------|----------|------|--|--|--|
| Dim | Min | Max | | | |
| Α | _ | 1.75 | | | |
| A1 | 0.10 | 0.20 | | | |
| A2 | 1.30 | 1.50 | | | |
| A3 | 0.15 | 0.25 | | | |
| b | 0.3 | 0.5 | | | |
| D | 4.85 | 4.95 | | | |
| Е | 5.90 | 6.10 | | | |
| E1 | 3.85 | 3.95 | | | |
| е | 1.27 Тур | | | | |
| h | _ | 0.35 | | | |
| L | 0.62 | 0.82 | | | |
| θ | 0° | 8° | | | |
| All Dimensions in mm | | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Х | 0.60 |
| Y | 1.55 |
| C1 | 5.4 |
| C2 | 1.27 |

SO-8



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